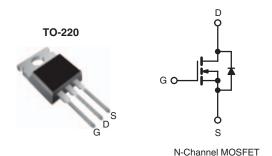




Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	100				
$R_{DS(on)}\left(\Omega\right)$	$V_{GS} = 5.0 \text{ V}$	0.54			
Q _g (Max.) (nC)	6.1				
Q _{gs} (nC)	2.6				
Q _{gd} (nC)	3.3				
Configuration	Single				



FEATURES

- Dynamic dV/dt Rating
- · Repetitive Avalanche Rated
- · Logic-Level Gate Drive
- R_{DS(on)} Specified at V_{GS} = 4 V and 5 V
- 175 °C Operating Temperature
- · Fast Switching
- · Ease of Paralleling
- Lead (Pb)-free Available

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220 contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220
Lead (Pb)-free	IRL510PbF
Lead (Fb)-liee	SiHL510-E3
SnPb	IRL510
SILL	SiHL510

ABSOLUTE MAXIMUM RATINGS T	C = 23 O, u	THE 33 OTHER W		LIBAIT		
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	100	V	
Gate-Source Voltage			V_{GS}	± 10		
Continuous Drain Current	V _{GS} at 5 V	T _C = 25 °C		5.6		
		T _C = 100 °C	I _D	4.0	Α	
Pulsed Drain Current ^a			I _{DM}	18		
Linear Derating Factor				0.29	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	100	mJ	
Repetitive Avalanche Current ^a			I _{AR}	5.6	Α	
Repetitive Avalanche Energy ^a			E _{AR}	4.3	mJ	
Maximum Power Dissipation	um Power Dissipation $T_C = 25 ^{\circ}C$			43	W	
Peak Diode Recovery dV/dtc			dV/dt	5.5	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 175	°C	
Soldering Recommendations (Peak Temperature)	for 10 s			300 ^d]	
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in	
			-	1.1	N · m	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. V_{DD} = 25 V, starting T_J = 25 °C, L = 4.8 mH, R_G = 25 Ω , I_{AS} = 5.8 A (see fig. 12).
- c. $I_{SD} \le 5.6$ A, $dI/dt \le 75$ A/µs, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C.
- d. 1.6 mm from case.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62		
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50	-	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	3.5		

PARAMETER	SYMBOL	TES	TEST CONDITIONS			MAX.	UNIT	
Static		•						
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	100	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	0.12	-	V/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	: V _{GS} , I _D = 250 μA	1.0	-	2.0	V	
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 10 V		-	± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =	V _{DS} = 100 V, V _{GS} = 0 V		-	25	μА	
		V _{DS} = 80 V	V _{DS} = 80 V, V _{GS} = 0 V, T _J = 150 °C		-	250		
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 5.0 V	I _D = 3.4 A ^b	-	-	0.54	Ω	
		V _{GS} = 4.0 V	I _D = 2.8 A ^b	-	-	0.76		
Forward Transconductance	9 _{fs}	V _{DS} = 50 V, I _D = 3.4 A ^b		1.9	-	-	S	
Dynamic					•	•		
Input Capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ $f = 1.0 \text{ MHz}, \text{ see fig. 5}$		-	250	-	pF	
Output Capacitance	C _{oss}			-	80	-		
Reverse Transfer Capacitance	C _{rss}			-	15	-		
Total Gate Charge	Qg			-	-	6.1		
Gate-Source Charge	Q _{gs}	V _{GS} = 5.0 V	$V_{GS} = 5.0 \text{ V}$ $I_D = 5.6 \text{ A}, V_{DS} = 80 \text{ V}$ see fig. 6 and 13 ^b		-	2.6	nC	
Gate-Drain Charge	Q _{gd}	1	see lig. 6 and 13	-	-	3.3	1	
Turn-On Delay Time	t _{d(on)}			-	9.3	-		
Rise Time	t _r	$V_{DD}=50~V,~I_{D}=5.6~A$ $R_{G}=12~\Omega,~R_{D}=8.4~\Omega$ see fig. 10^{b}		-	47	-	ns	
Turn-Off Delay Time	t _{d(off)}			-	16	-		
Fall Time	t _f			-	18	-		
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	- nH	
Internal Source Inductance	L _S			-	7.5	-		
Drain-Source Body Diode Characteristic	s	•						
Continuous Source-Drain Diode Current	I _S	showing the	MOSFET symbol showing the		-	5.6	- A	
Pulsed Diode Forward Current ^a	I _{SM}	integral reverse p - n junction diode		-	-	18		
Body Diode Voltage	V_{SD}	$T_J = 25 ^{\circ}\text{C}, \ I_S = 5.6 \text{A}, \ V_{GS} = 0 \text{V}^{\text{b}}$		-	-	2.5	V	
Body Diode Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = 5.6 A, dl/dt = 100 A/μs ^b		-	110	130	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.50	0.65	μC	
		Intrinsic turn-on time is negligible (turn-on i			1	ated by L _S and L _D)		

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 μ s; duty cycle \leq 2 %.



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

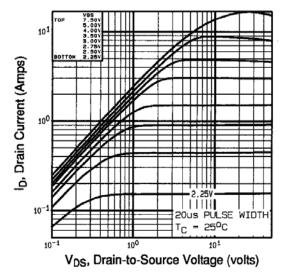


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

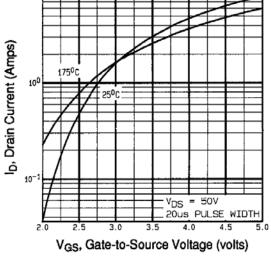


Fig. 3 - Typical Transfer Characteristics

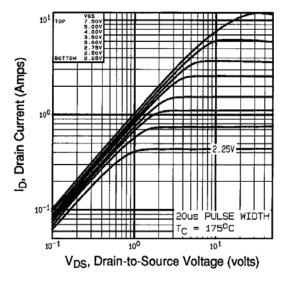


Fig. 3 - Fig. 2 - Typical Output Characteristics, T_C = 175 °C

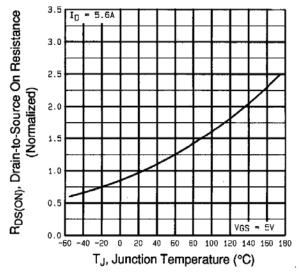


Fig. 4 - Normalized On-Resistance vs. Temperature

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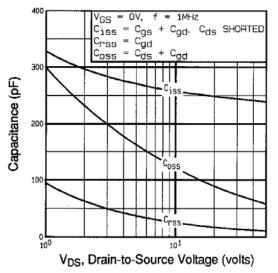


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

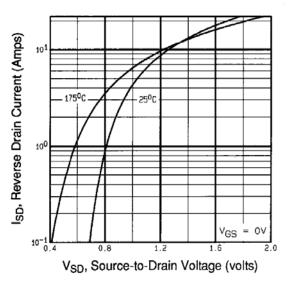


Fig. 7 - Typical Source-Drain Diode Forward Voltage

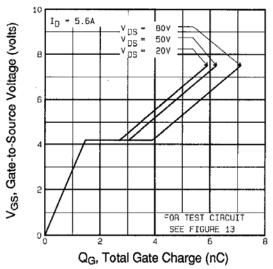


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

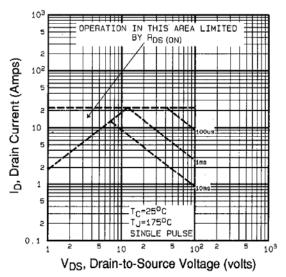


Fig. 8 - Maximum Safe Operating Area





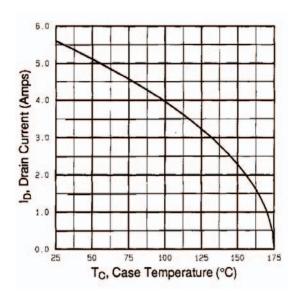


Fig. 9 - Maximum Drain Current vs. Case Temperature

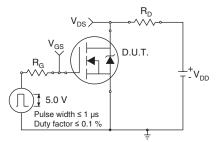


Fig. 10a - Switching Time Test Circuit

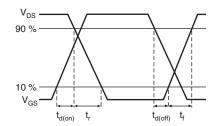


Fig. 10b - Switching Time Waveforms

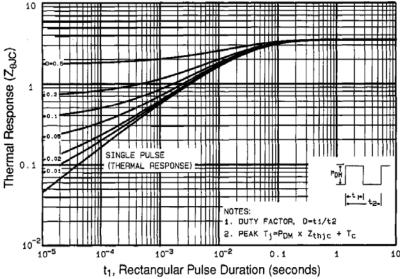


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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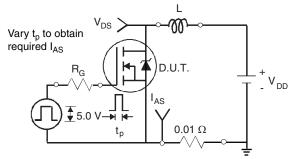


Fig. 12a - Unclamped Inductive Test Circuit

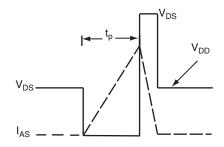


Fig. 12b - Unclamped Inductive Waveforms

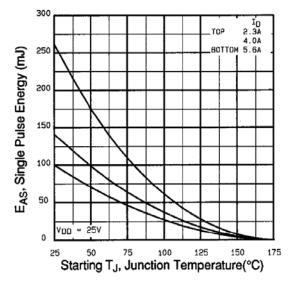


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

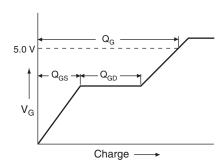


Fig. 13a - Basic Gate Charge Waveform

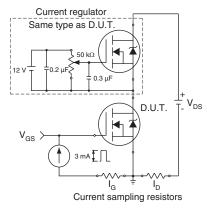
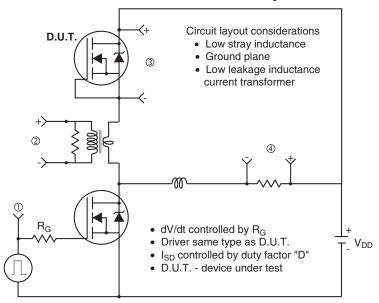
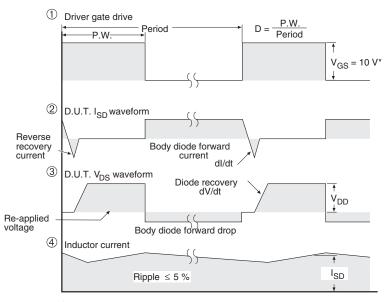


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit





* $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

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